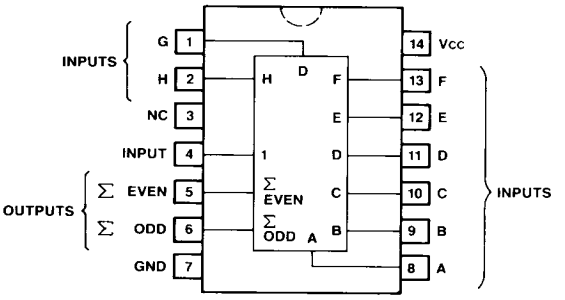
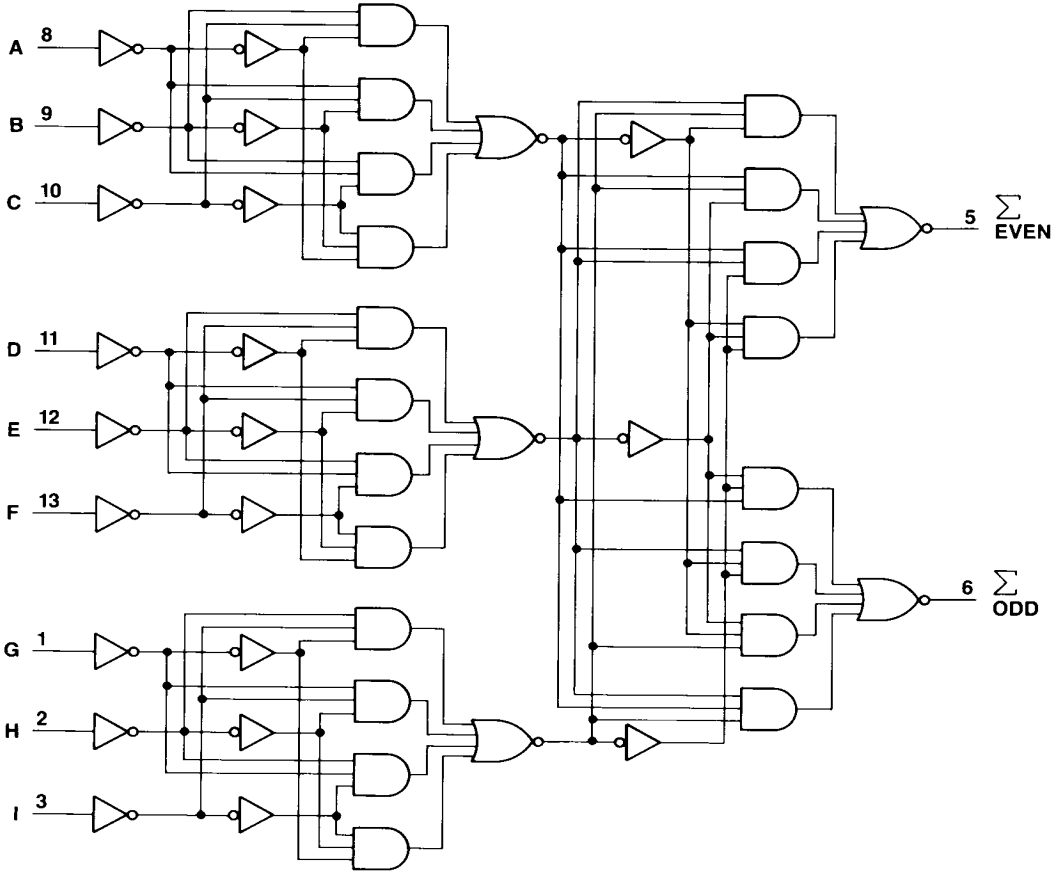
9-Bit Parity Generator/Checker

The LS280 is a bipolar, NPN, sealed-junction, silicon integrated circuit. It is manufactured in low-power Schottky technology and is available in a wire-bonded, 14-pin plastic DIP or surface mount package.



Logic Diagram



Electrical Characteristics

V_{CC} = 5.0 ±0.5 V, T_A = −55 to +125°C (WA-LS)
V_{CC} = 5.0 ±0.25 V, T_A = 0 to 70°C (WP90352L2)
V_{CC} = 5.0 ±0.5 V, T_A = −40 to +85°C (WP91400L3)

		WA-LS		WP		
Parameter	**Symbol**	**Min**	**Max**	**Min**	**Max**	**Units**
Output Voltage, V_{CC} = 4.5 V (WA-LS), 4.75 V (WP)						
Low, I_{OL} = 4.0 mA	V_{OL}	—	0.4	—	0.4	V
I_{OL} = 8.0 mA	V_{OL}	—	0.5	—	0.5	V
High, I_{OH} = −0.4 mA	V_{OH}	2.5	—	2.7	—	V
Input Voltage, V_{CC} = 4.5 V (WA-LS), 4.75 V (WP)						
Low	V_{IL}	—	0.7	—	0.8*	V
High	V_{IH}	2.0	7.5	2.0	5.5	V
Clamp, I_{IN} = −18.0 mA	V_{IK}	—	−1.5	—	−1.5	V
Input Current, V_{CC} = 5.5 V (WA-LS), 5.25 V (WP)						
Low, V_{IL} = 0.4 V	I_{IL}	—	−0.4	—	−0.4	mA
High, V_{IH} = 2.7 V	I_{IH}	—	20.0	—	20.0	μA
@ V_I max, V_I = 7.0 V (WA-LS), 5.5 V (WP)	I_I	—	0.1	—	0.1	mA
Output Current, V_{CC} = 5.5 V (WA-LS), 5.25 V (WP)						
Short-Circuit	I_{OS}	−20.0	−100.0	−20.0	−100.0	mA
Supply Current, V_{CC} = 5.5 V (WA-LS), 5.25 V (WP)	I_{CC}	—	27.0	—	27.0	mA

* WP91400L3: V_{IL} = 0.7 V

Timing Characteristics

V_{CC} = 5.0 V, T_A = 25°C, C_L = 15 pF

		WA-LS		WP		
Parameter	**Symbol**	**Min**	**Max**	**Min**	**Max**	**Units**
Propagation Delay						
Data to Output (Σ Even)						
Low-to-High	t_{PLH}	—	50.0	—	50.0	ns
High-to-Low	t_{PHL}	—	45.0	—	45.0	ns
Data to Output (Σ Odd)						
Low-to-High	t_{PLH}	—	35.0	—	35.0	ns
High-to-Low	t_{PHL}	—	50.0	—	50.0	ns

Maximum Ratings

Power supply voltage (V_{CC}) . . . . . 7.0 V
Operating temperature (T_A) . . . . . WA-LS: −55 to +125°C
WP90352L2: 0 to 70°C
WP91400L3: −40 to +85°C
Storage temperature (T_{stg}) . . . . . −65 to +150°C

Maximum ratings are defined as the limiting conditions that the user can apply to the device under all variations of circuit and environmental conditions. If any rating is exceeded, permanent damage to the device may result.

Bonding or soldering of the external leads of this device can be performed safely at temperatures up to 300°C.